



RoHS TEST REPORT

For

LED BULB

Model No.: VT-2059

Applicant : V-TAC EXPORTS LIMITED

ROOM NO.301, KAM ON BUILDING 176A QUEENS ROAD CENTRAL,
CENTRAL, HONGKONG

Manufacturer : V-TAC EXPORTS LIMITED

ROOM NO.301, KAM ON BUILDING 176A QUEENS ROAD CENTRAL,
CENTRAL, HONGKONG

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Report Number : J00.06.0013R

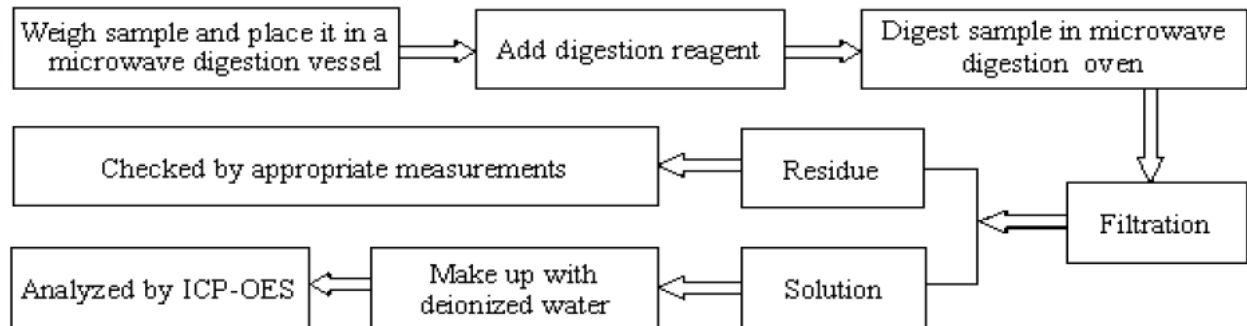
Issued Date : January 17, 2017

Date of Report : January 17, 2017

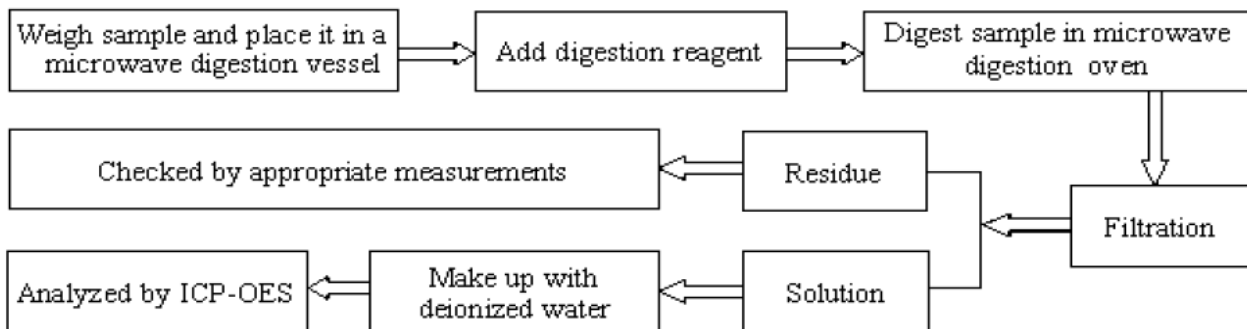
Note:

1. The test data and result is based on the tested sample only.
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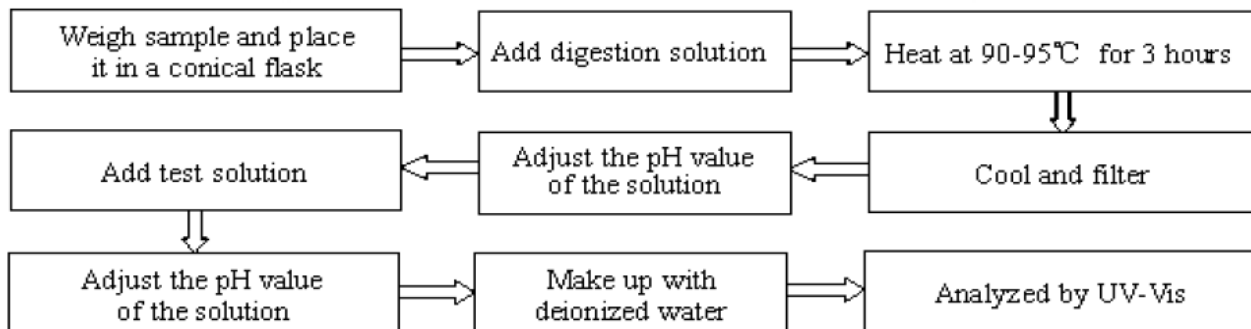
1. Lead(Pb), Cadmium(Cd)



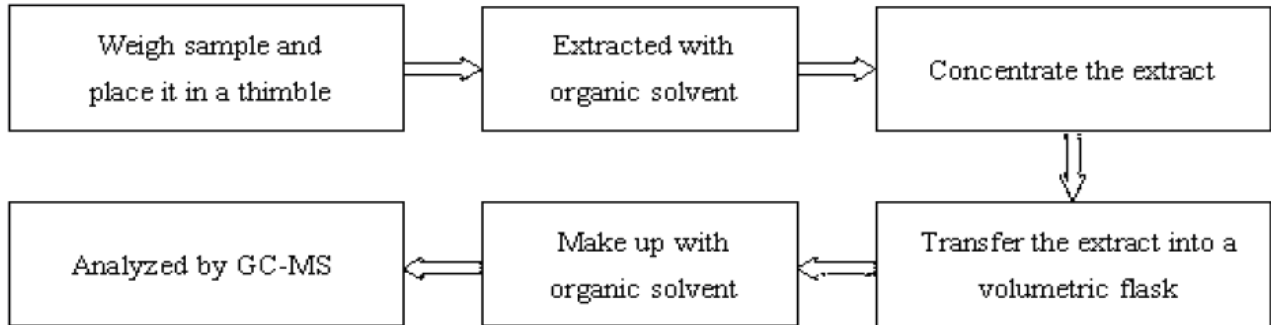
2. Mercury(Hg)



3. Hexavalent Chromium (Cr(VI))





**4. Polybrominated Biphenyls (PBBs), Polybrominated Diphenyl Ethers(PBDEs) ,
HBCDD, DBP, DEHP, BBP**



Method Detection Limit (MDL) in wet chemical test

Test Items	Pb	Cd	Hg	PBBs & PBDEs
Unit	mg/kg	mg/kg	mg/kg	mg/kg
MDL	2	2	2	2

Result	:	Pass
Conclusion	:	An independent evaluation on the above-mentioned product(s) has been conducted pursuant to 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment, and concluded that the equipment under evaluation met the legislative requirements of this directive.

Reviewed by

 APPROVED
 Tim Sun
 Manager
 January 17, 2017


Test Data Summary

SAMPLE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusion (P/F)
1	lamp base	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
2	Plastic enclosure	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
3	Lamp cover	Cd	P	/	<100	N.A.
		Cr	P	/	<1000	N.A.
		Hg	P	/	<1000	N.A.
		Pb	P	/	<1000	N.A.
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
4	Metal Enclosure	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	/	<1000	N.A.
		PBDEs	D	/	<1000	N.A.
		HBCDD	D	/	<1000	N.A.
		DEHP	D	/	<1000	N.A.
		DBP	D	/	<1000	N.A.
		BBP	D	/	<1000	N.A.

SAMPLE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusion (P/F)
5	Internal wire	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
6	Glue	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
7	LED	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P
8	LED PCB	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
		BBP	D	N.D.	<1000	P

SAMP LE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusio n (P/F)
9	PCB of LED driver	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
10	Rectifier	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
11	Resistors	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
12	Capacitors	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
BBP	D	N.D.	<1000	P		

SAMP LE NO.	COMPONENTS	Item	Results of EDXRF (P/F/D)	Results of testing(mg/kg)	Chemical testing limit (mg/kg)	Conclusio n (P/F)
13	IC	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
14	Diodes	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
15	Inductance	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	N.D.	<1000	P
		PBDEs	D	N.D.	<1000	P
		HBCDD	D	N.D.	<1000	P
		DEHP	D	N.D.	<1000	P
		DBP	D	N.D.	<1000	P
16	Soldering tin	Cd	P	N.D.	<100	P
		Cr	P	N.D.	<1000	P
		Hg	P	N.D.	<1000	P
		Pb	P	N.D.	<1000	P
		PBBs	D	/	<1000	N.A.
		PBDEs	D	/	<1000	N.A.
		HBCDD	D	/	<1000	N.A.
		DEHP	D	/	<1000	N.A.
		DBP	D	/	<1000	N.A.
BBP	D	/	<1000	N.A.		



Report Reference No.: J00.06.0013R

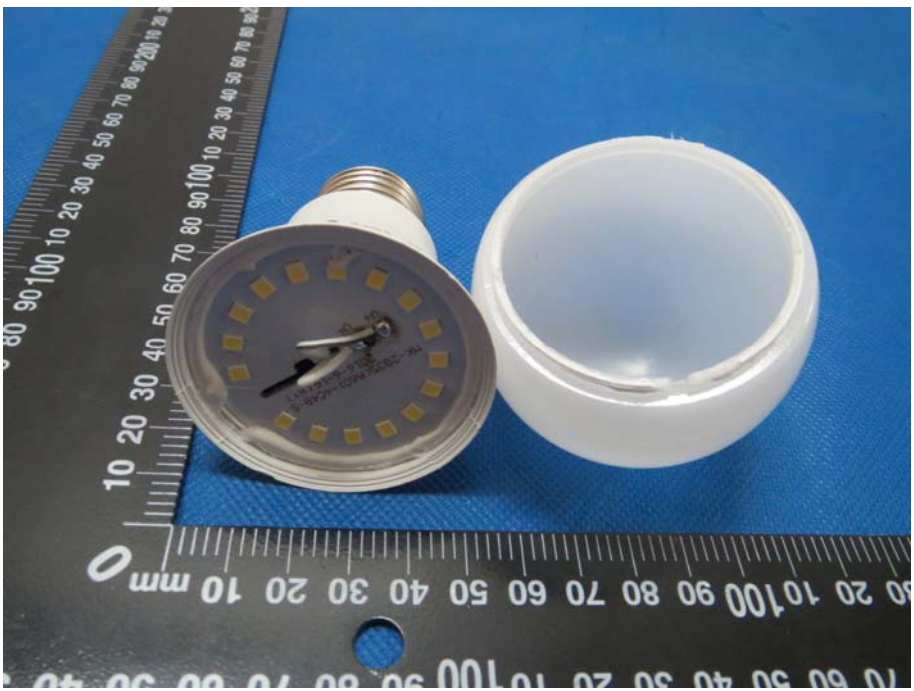
Note:

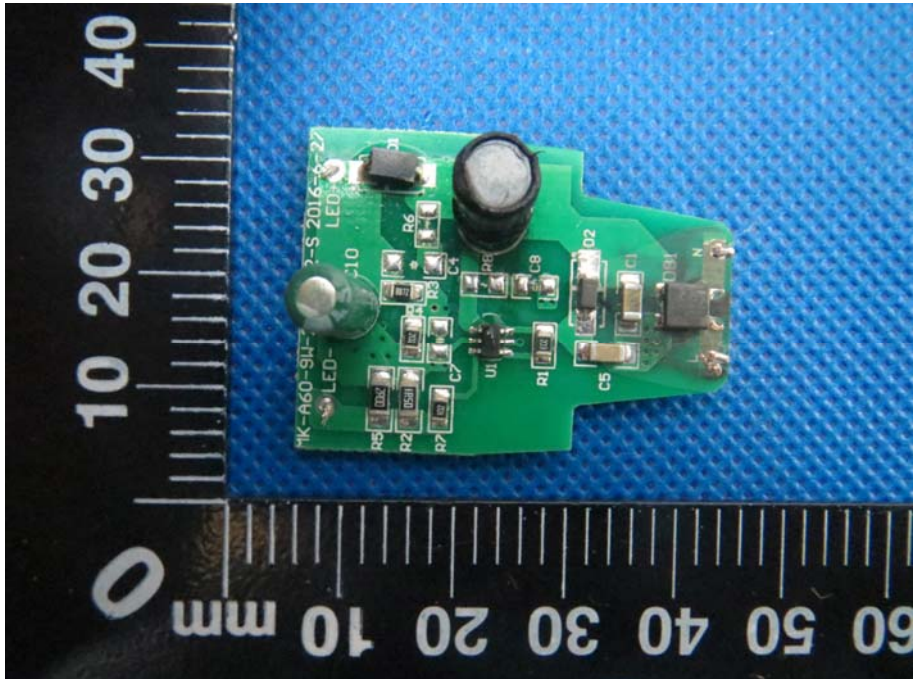
- (1) N.D. = Not detected (<MDL)
- (2) ppm = mg/kg
- (3) N.A. = Not Analyzed
- (4) Negative = the concentration of Hexavalent Chromium extracted from 50cm² sample is less than the detection limit.

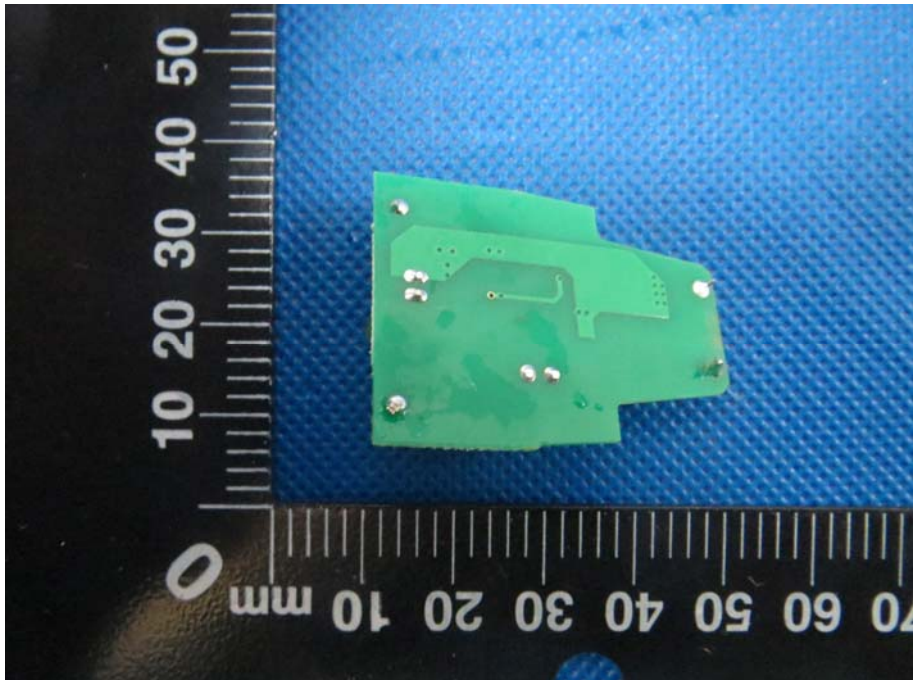
Appendix 1

Photo documentation

<p>Photo 1</p> <p>View:</p> <p><input checked="" type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input type="checkbox"/> Internal</p>	
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<p>Photo 2</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input checked="" type="checkbox"/> Internal</p>	
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<p>Photo 3</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input checked="" type="checkbox"/> Internal</p>	 <p>A photograph showing the internal view of a green printed circuit board (PCB). The board is populated with various electronic components, including a large black cylindrical component, several surface-mount components, and a USB connector. A ruler is placed below the board for scale, showing measurements in millimeters. The board is resting on a blue textured surface.</p>
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<p>Photo 4</p> <p>View:</p> <p><input type="checkbox"/> Front</p> <p><input type="checkbox"/> Rear</p> <p><input type="checkbox"/> Right side</p> <p><input type="checkbox"/> Left side</p> <p><input type="checkbox"/> Top</p> <p><input type="checkbox"/> Bottom</p> <p><input checked="" type="checkbox"/> Internal</p>	 <p>A photograph showing the internal view of a green printed circuit board (PCB). The board is mostly empty, with a few small components and traces visible. A ruler is placed below the board for scale, showing measurements in millimeters. The board is resting on a blue textured surface.</p>
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--END.--